Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Joerg Berthold	10/04/2007
Winfried Kamp	10/05/2007
Fritz Rothacher	10/04/2007

RECEIVING PARTY DATA

Name:	Infineon Technologies AG
Street Address:	Am Campeon 1-12
City:	Neubiberg
State/Country:	GERMANY
Postal Code:	85579

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11860413

CORRESPONDENCE DATA

Fax Number: (612)573-2005

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

scheff@dbclaw.com Email:

Correspondent Name: Dicke, Billig & Czaja, P.L.L.C.

Address Line 1: 100 South Fifth Street

Suite 2250 Address Line 2:

Address Line 4: Minneapolis, MINNESOTA 55402

1560.130.101 ATTORNEY DOCKET NUMBER:

NAME OF SUBMITTER: Steven E. Dicke

Total Attachments: 3

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PATENT **REEL: 020030 FRAME: 0636**

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PATENT REEL: 020030 FRAME: 0637

ASSIGNMENT

For good and valuable consideration, We, Joerg Berthold, a citizen of Germany, residing at Einsteinstr. 46, 81675Muenchen, Germany, and Winfried Kamp, a citizen of Germany, residing at Hans-Schweikart-Str. 6, 81739 Muenchen, Germany, and Fritz Rothacher, a citizen of Switzerland, residing at Werdenferster Strasse 41D, 86163 Augsburg, hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to **Infineon Technologies AG**, a corporation, organized and existing under the laws of Germany, having its principal place of business at Am Campeon 1-12, Neubiberg, Germany 85579, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and filed herewith, entitled:

METHOD OF FABRICATING AN INTEGRATED CIRCUIT WITH STRESS ENHANCEMENT

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, it successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE:

DATE:

DATE:

SIGNATURE:

NAME: Winfried Kamp

DATE:

NAME: Winfried Kamp

DATE:

NAME: Fritz Rothacher

ASSIGNMENT

For good and valuable consideration, We, Joerg Berthold, a citizen of Germany, residing at Einsteinstr. 46, 81675Muenchen, Germany, and Winfried Kamp, a citizen of Germany, residing at Hans-Schweikart-Str. 6, 81739 Muenchen, Germany, and Fritz Rothacher, a citizen of Switzerland, residing at Werdenferster Strasse 41D, 86163 Augsburg, hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to Infineon Technologies AG, a corporation, organized and existing under the laws of Germany, having its principal place of business at Am Campeon 1-12, Neubiberg, Germany 85579, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and filed herewith, entitled:

METHOD OF FABRICATING AN INTEGRATED CIRCUIT WITH STRESS ENHANCEMENT

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, it successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE:	•		DATE:	
	NAME: Joerg Berthold			
SIGNATURE:	Winfreed NAME: Winfried Kamp	Kanp	DATE:	05.10.2007
SIGNATURE:	NAME: Fritz Rothacher		DATE:	

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Ref No. 2007P521200US OC Ref No. 1560.130.101

ASSIGNMENT

For good and valuable consideration, We, Joerg Berthold, a citizen of Germany, residing at Einsteinstr. 46, 81675Muenchen, Germany, and Winfried Kamp, a citizen of Germany, residing at Hans-Schweikart-Str. 6, 81739 Muenchen, Germany, and Fritz Rothacher, a citizen of Switzerland, residing at Werdenferster Strasse 41D, 86163 Augsburg, hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to Infineon Technologies AG, a corporation, organized and existing under the laws of Germany, having its principal place of business at Am Campeon 1-12, Neubiberg, Germany 85579, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and filed herewith, entitled:

METHOD OF FABRICATING AN INTEGRATED CIRCUIT WITH STRESS ENHANCEMENT

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries or, said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignce, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, it successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE:		DATE:	
	NAME: Joerg Berthold	(
SIGNATURE:		DATE:	
	NAME: Winfried Kamp		
SIGNATURE:	I Tallel	DATE:	4. Oct 07
	NAME: Fritz Rothacher		•

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RECORDED: 10/29/2007

PATENT REEL: 020030 FRAME: 0640